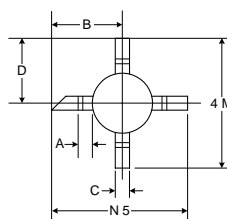


Typical Applications

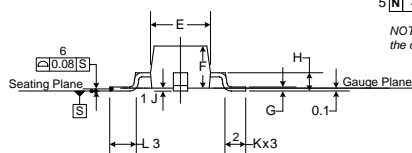
- Narrow and Broadband Commercial and Military Radio Designs
- Linear and Saturated Amplifiers
- Gain Stage or Driver Amplifiers for MW Radio/Optical Designs (PTP/PMP/LMDS/UNII/VSAT/WLAN/Cellular/DWDM)

Product Description

The NLB-300 cascable broadband InGaP/GaAs MMIC amplifier is a low-cost, high-performance solution for general purpose RF and microwave amplification needs. This 50Ω gain block is based on a reliable HBT proprietary MMIC design, providing unsurpassed performance for small-signal applications. Designed with an external bias resistor, the NLB-300 provides flexibility and stability. The NLB-300 is packaged in a low-cost, surface-mount plastic package, providing ease of assembly for high-volume tape-and-reel requirements.



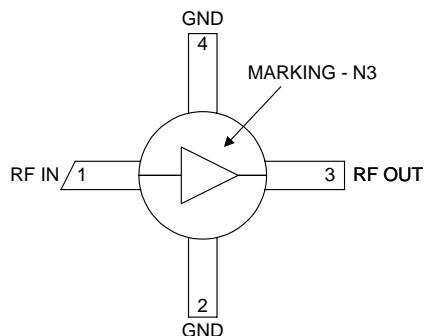
	MILLIMETERS			INCHES		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.535 REF.			0.021 REF.		
B	2.39	2.54	2.69	0.094	0.100	0.106
C	0.436	0.510	0.586	0.017	0.020	0.023
D	2.19	2.34	2.49	0.086	0.092	0.098
E	1.91	2.16	2.41	0.075	0.085	0.095
F	1.32	1.52	1.72	0.052	0.060	0.068
G	0.10	0.15	0.20	0.004	0.006	0.008
H	0.535	0.660	0.785	0.021	0.026	0.031
J	0.05	0.10	0.15	0.002	0.004	0.006
K	0.65	0.75	0.85	0.025	0.029	0.033
L	0.85	0.95	1.05	0.033	0.037	0.041
M	4.53	4.68	4.83	0.178	0.184	0.190
N	4.73	4.88	5.03	0.186	0.192	0.198



NOTE: All dimensions are in millimeters, and the dimensions in inches are for reference only.

Optimum Technology Matching® Applied

- | | | |
|---|-----------------------------------|---------------------------------------|
| <input type="checkbox"/> Si BJT | <input type="checkbox"/> GaAs HBT | <input type="checkbox"/> GaAs MESFET |
| <input type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS |
| <input checked="" type="checkbox"/> InGaP/HBT | <input type="checkbox"/> GaN HEMT | <input type="checkbox"/> SiGe Bi-CMOS |



Functional Block Diagram

Package Style: Micro-X, 4-Pin, Plastic

Features

- Reliable, Low-Cost HBT Design
- 13.0dB Gain, +11.1dBm P1dB @ 2GHz
- High P1dB of +14.1dBm @ 6.0GHz and +12.7dBm @ 10.0GHz
- Single Power Supply Operation
- 50Ω I/O Matched for High Freq. Use

Ordering Information

NLB-300	Cascable Broadband GaAs MMIC Amplifier DC to 10GHz
NLB-300-T1 or -T3	Tape & Reel, 1000 or 3000 Pieces (respectively)
NLB-300-E	Fully Assembled Evaluation Board
NBB-X-K1	Extended Frequency InGaP Amp Designer's Tool Kit
RF Micro Devices, Inc.	Tel (336) 664 1233
7628 Thorndike Road	Fax (336) 664 0454
Greensboro, NC 27409, USA	http://www.rfmd.com

NLB-300

Absolute Maximum Ratings

Parameter	Rating	Unit
RF Input Power	+20	dBm
Power Dissipation	300	mW
Device Current	70	mA
Channel Temperature	200	°C
Operating Temperature	-45 to +85	°C
Storage Temperature	-65 to +150	°C

Exceeding any one or a combination of these limits may cause permanent damage.



Caution! ESD sensitive device.

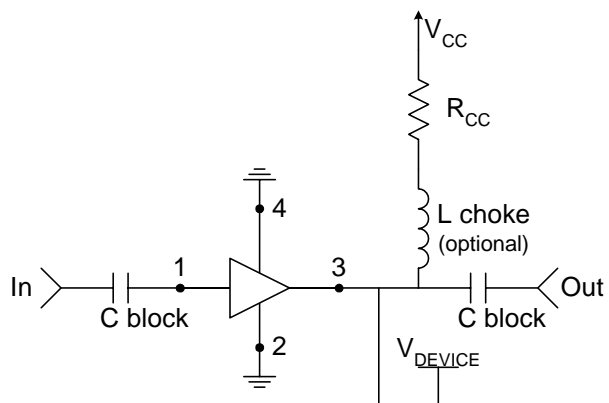
RF Micro Devices believes the furnished information is correct and accurate at the time of this printing. However, RF Micro Devices reserves the right to make changes to its products without notice. RF Micro Devices does not assume responsibility for the use of the described product(s).

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Overall					$V_D = +3.8V$, $I_{CC} = 50mA$, $Z_0 = 50\Omega$, $T_A = +25^\circ C$
Small Signal Power Gain, S21	12.0	13.0		dB	$f = 0.1GHz$ to $1.0GHz$
		10.7		dB	$f = 1.0GHz$ to $4.0GHz$
		8.9		dB	$f = 4.0GHz$ to $6.0GHz$
	8.5	8.9		dB	$f = 6.0GHz$ to $10.0GHz$
		8.5		dB	$f = 10.0GHz$ to $12.0GHz$
Gain Flatness, GF		± 0.1		dB	$f = 5.0GHz$ to $10.0GHz$
Input VSWR		2.2:1			$f = 0.1GHz$ to $4.0GHz$
		2.8:1			$f = 4.0GHz$ to $7.0GHz$
		2.0:1			$f = 7.0GHz$ to $12.0GHz$
Output VSWR		2.2:1			$f = 0.1GHz$ to $4.0GHz$
		2.9:1			$f = 4.0GHz$ to $7.0GHz$
		2.4:1			$f = 7.0GHz$ to $12.0GHz$
Output Power @ -1 dB Compression, P1dB		11.1		dBm	$f = 2.0GHz$
		14.1		dBm	$f = 6.0GHz$
		12.7		dBm	$f = 10.0GHz$
Noise Figure, NF		4.9		dB	$f = 3.0GHz$
Third Order Intercept, IP3		+28.6		dBm	$f = 2.0GHz$
		+27.0			$f = 6.0GHz$
Reverse Isolation, S12		-16		dB	$f = 0.1GHz$ to $20.0GHz$
Device Voltage, V_D	3.6	3.8	4.2	V	
Gain Temperature Coefficient, $\delta G_T / \delta T$		-0.0015		dB/°C	
MTTF versus Temperature @ $I_{CC} = 50mA$					
Case Temperature		85		°C	
Junction Temperature		113		°C	
MTTF		>1,000,000		hours	
Thermal Resistance					
θ_{JC}		147		°C/W	$\frac{J_T - T_{CASE}}{V_D \cdot I_{CC}} = \theta_{JC} (^\circ C / Watt)$

Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. This pin is NOT internally DC-blocked. A DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
2	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
3	RF OUT	<p>RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V_{CC}. The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation:</p> $R = \frac{(V_{CC} - V_{DEVICE})}{I_{CC}}$ <p>Care should also be taken in the resistor selection to ensure that the current into the part never exceeds maximum datasheet operating current over the planned operating temperature. This means that a resistor between the supply and this pin is always required, even if a supply near 5.0V is available, to provide DC feedback to prevent thermal runaway. Because DC is present on this pin, a DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed.</p>	
4	GND	Same as pin 2.	

Typical Bias Configuration

Application notes related to biasing circuit, device footprint, and thermal considerations are available on request.

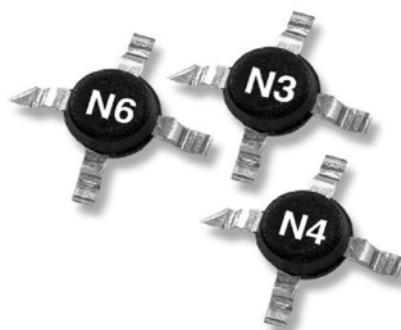
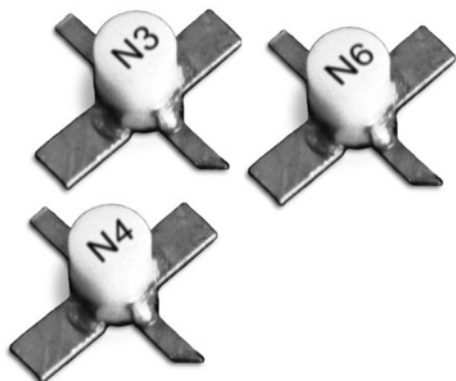


Recommended Bias Resistor Values						
Supply Voltage, V _{CC} (V)	5	8	10	12	15	20
Bias Resistor, R _{CC} (Ω)	22	82	122	162	222	322

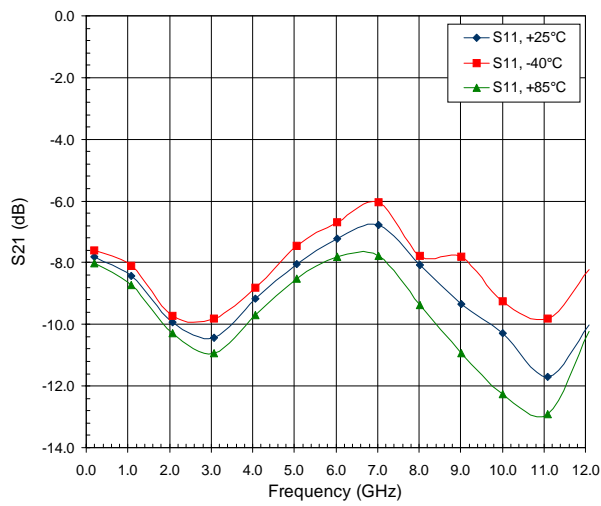
Extended Frequency InGaP Amplifier Designer's Tool Kit NBB-X-K1

This tool kit was created to assist in the design-in of the RFMD NBB- and NLB-series InGaP HBT gain block amplifiers. Each tool kit contains the following.

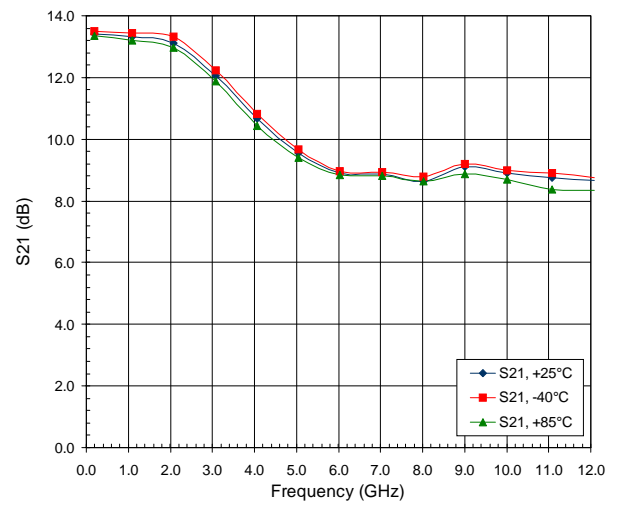
- 5 each NBB-300, NBB-310 and NBB-400 Ceramic Micro-X Amplifiers
- 5 each NLB-300, NLB-310 and NLB-400 Plastic Micro-X Amplifiers
- 2 Broadband Evaluation Boards and High Frequency SMA Connectors
- Broadband Bias Instructions and Specification Summary Index for ease of operation



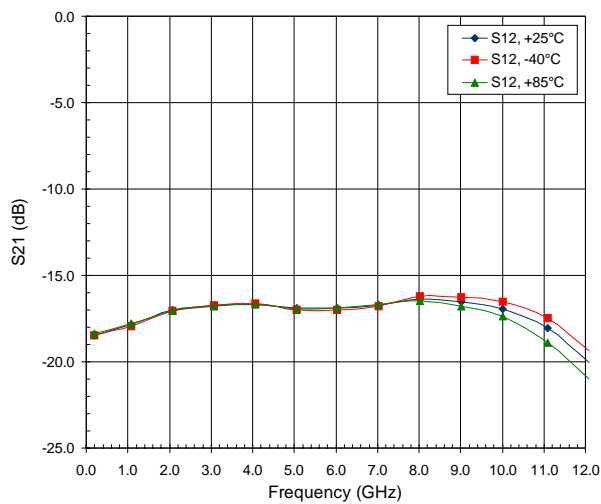
S11 versus Frequency, Over Temperature



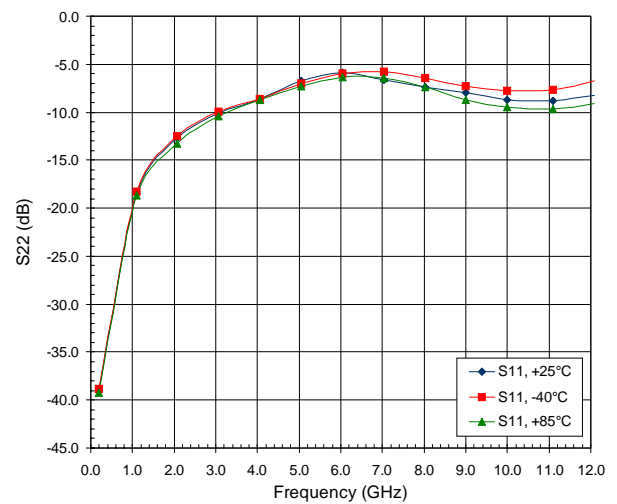
S21 versus Frequency, Over Temperature



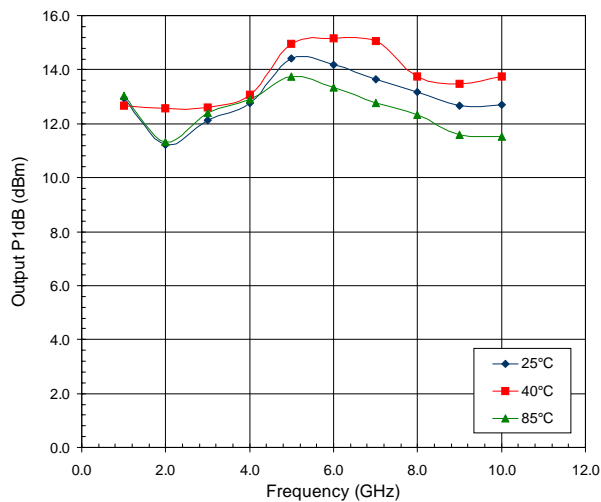
S12 versus Frequency, Over Temperature



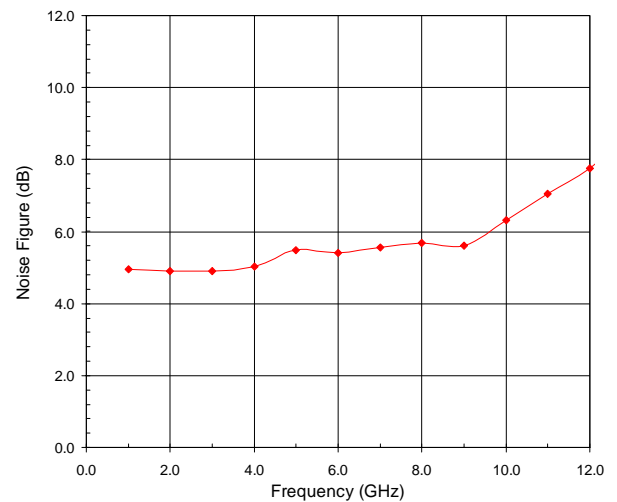
S22 versus Frequency, Over Temperature



Output P1dB versus Frequency Across Temperature



Noise Frequency versus Frequency at +25°C



NLB-300

Note: The s-parameter gain results shown include device performance as well as evaluation board and connector loss variations. The insertion losses of the evaluation board and connectors are as follows:

1 GHz to 4 GHz=-0.06dB

5 GHz to 9 GHz=-0.22dB

10 GHz to 14 GHz=-0.50dB

15 GHz to 20 GHz=-1.08dB